Features

660ns µP-Compatible, 8-Bit ADC with Track/Hold

General Description

The MX7821 high-speed, microprocessor-compatible (μP), 8-bit analog-to-digital converter (ADC) is a plug-in upgrade for the industry-standard 7820. The MX7821 uses a half-flash technique, resulting in a 660ns conversion time vs. 1.36 \(\mu \) for the 7820. A Vss pin, not supplied by the 7820, supports dual power supplies and bipolar analog inputs.

The MX7821 has track-and-hold function capable of digitizing a 100kHz signal, and is tested for both its static and dynamic capability. The converter-µP interface appears as a memory location or input/output port that requires no external interface logic. The data outputs use latched, three-state buffered circuitry for direct connection to a µP data bus or system input port. The MX7821 has an overflow output for cascading devices to attain higher resolution. The ADC's input/reference arrangement enables ratiometric operation. For a detailed description of MX7821 operation, refer to the MX7820 data sheet.

Applications

Digital-Signal Processing High-Speed Data Acquisition Telecommunications High-Speed Servo Loops Audio Systems

660ns Conversion Time

- 20-Pin Narrow DIP Package
- No External Clock
- Pin-Compatible Upgrade for Industry-Standard 7820
- 100kHz Input Signal Bandwidth
- Bipolar/Unipolar Inputs
- Single +5V or Dual ±5V Supplies
- Ratiometric Reference Inputs
- Static and Dynamic Tested
- Internal Track/Hold

Ordering Information

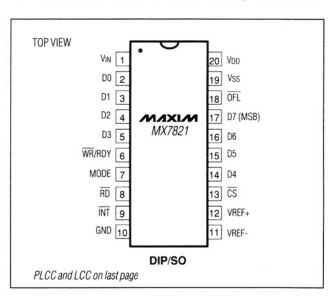
PART	TEMP. RANGE	PIN-PACKAGE	
MX7821KN	0°C to +70°C	20 Plastic DIP	
MX7821KR	0°C to +70°C	20 Wide SO	
MX7821KP	0°C to +70°C	20 PLCC	
MX7821K/D	0°C to +70°C	Dice*	
MX7821BQ	-40°C to +85°C	20 CERDIP	
MX7821KEWP	-40°C to +85°C	20 Wide SO	
MX7821TE	-55°C to +125°C	20 LCC**	
MX7821TQ	-55°C to +125°C	20 CERDIP**	

Contact factory for dice specifications.

Functional Diagram

VDD 20 18___ __ OFL VREF+ 4-RIT FLASH VREF-ADC VIN D0-D7 DATA THREE-4-BIT DAC STATE OUT DRIVERS PINS 2-5, 14-17 VREF+ 4-BIT FLASH 16 (4LSB) MAXIM MX7821 TIMING AND CONTROL CIRCUITRY 19 GND MODE WR/RDY CS RD INT Vss

Pin Configurations



/U/IXI/U

^{**} Contact factory for availability and processing to MIL-STD-883.

ABSOLUTE MAXIMUM RATINGS

VDD to GND -0.3V to +7V Vss to GND +0.3V to -7V Digital Output Voltage to GND (Pins 2-5, 9, 14-16, 18) (Pins 2-5, 9, 14-16, 18) -0.3V to VDD +0.3V VREF+ to AGND Vss -0.3V to VDD +0.3V VREF- to AGND Vss -0.3V to VDD +0.3V VIN to GND Vss -0.3V to VDD +0.3V Continuous Power Dissipation (any package) to +75°C to +75°C 1000mW derate above +75°C by 10mW/°C	Operating Temperature Ranges: 0°C to +70°C MX7821K
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Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

 $(V_{DD} = +5V \pm 5\%; GND = 0V; Unipolar Input Range: V_{SS} = 0V, VREF_{+} = 5V, VREF_{-} = 0V; Bipolar Input Range: V_{SS} = -5V \pm 5\%, VREF_{+} = 2.5V, VREF_{-} = -2.5V; specifications apply for RD mode, Pin 7 = 0V; T_{A} = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 1)$

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
UNIPOLAR INPUT RANGE							
Resolution	N			8			Bits
Total Unadjusted Error (Note 2)	TUE					±1	LSB
No Missing Codes Resolution				8			Bits
BIPOLAR INPUT RANGE							
Resolution	N			8			Bits
Zero-Code Error						±1	LSB
Full-Scale Error						±1	LSB
Signal-to-Noise Ratio	SNR	V _{IN} = 99.85kHz full-scale fSAMPLING = 500kHz	sine wave with	45			dB
Total Harmonic Distortion	THD	V _{IN} = 99.85kHz full-scale sine wave with fSAMPLING = 500kHz				-50	dB
Peak Harmonic or Spurious Noise		V _{IN} = 99.85kHz full-scale sine wave with fSAMPLING = 500kHz				-50	dB
Intermodulation Distortion	IMD	f _a (84.72kHz) and f _b (94.97kHz) full-scale	2nd-order terms			-50	dB
THE THOUGH AND THE THE	IIVID	sine waves with fSAMPL- ING = 500kHz	3rd-order terms			-50	ub ub
Slew Rate, Tracking					2.36	1.6	V/µs
REFERENCE INPUT							
Input Resistance		Resistance between VRE	F+ and VREF-	1		4	kΩ
VREF+ Input Range				VREF-		V _{DD}	٧
VREF- Input Range				VSS		VREF+	٧
ANALOG INPUT							
Input Voltage Range				VREF-		VREF+	٧
Input Leakage Current		-5V ≤ V _{IN} ≤ 5V				±3	μА
Input Capacitance	CIN				32		pF

ELECTRICAL CHARACTERISTICS (continued)

 $(V_{DD} = +5V \pm 5\%; GND = 0V; Unipolar Input Range: V_{SS} = 0V, VREF_{+} = 5V, VREF_{-} = 0V; Bipolar Input Range: V_{SS} = -5V \pm 5\%, VREF_{+} = 2.5V, VREF_{-} = -2.5V; specifications apply for RD mode, Pin 7 = 0V; T_{A} = T_{MIN} to T_{MAX}, unless otherwise noted.) (Note 1)$

PARAMETER	SYMBOL	C	ONDITIONS	MIN	TYP	MAX	UNITS	
LOGIC INPUTS				•				
India Haliana Valtaga	VINH	CS, WR, RD	2.4			_ v		
Input High Voltage	VINH	MODE		3.5			\ \ \	
Input Low Voltage	VINL	CS, WR, RD				0.8	V	
Input Low Voltage	VINL	MODE				1.5		
Input High Current		CS, RD				1		
	INH	WR				3	μΑ	
		MODE			50	200		
Input Low Current	INL					-1	μА	
Input Capacitance (Note 3)	CIN				5	8	pF	
LOGIC OUTPUTS								
Output Low Voltage	VOL	D7-D0, INT, OFL; ISINK = 1.6mA				0.4	V	
Output Low Voltage		RDY; I _{SINK} = 2.6mA				0.4		
Output High Voltage	Voh	D7-D0, ĪNT, ŌF	FL; ISOURCE = -360µA	4.0			V	
Floating State Leakage Current	ILKG	D7-D0, RDY				±3	μА	
Floating State Output Capacitance (Note 3)	Соит	D7-D0, RDY			5	8	pF	
POWER REQUIREMENTS							,	
	lpp		MX7821K			15	mA	
Supply Current	טטי	CS = RD = 0V	MAX7821B/T			20	111/4	
	Iss					100	μА	
Power Dissipation	PD				50		mW	
Power-Supply Sensitivity	PSR	V _{DD} = 4.75V to 5.25V, VREF+ = 4.75V MAX for unipolar mode			±1/16	±1/4	LSB	

Note 1: Performance over power-supply tolerance guaranteed by power-supply rejection test. Note 2: Total Unadjusted Error includes relative accuracy, zero-code error, and full-scale error. Note 3: Guaranteed by design.

TIMING CHARACTERISTICS

(VDD = +5V, VSS = 0V or -5V, Unipolar or Bipolar Input Range, TA = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
CS to RD/WR Setup Time	tcss			0			ns	
CS to RD/WR Hold Time	tcsh			0			ns	
CS to RDY Delay (Note 4)		$T_A = +25^{\circ}C$				70		
	trdy	t _{RDY}	TA = TMIN to TMAX	MX7821B/K			85	ns
		TA = TMIN TO TMAX	MX7821T			100		
		T _A = +25°C				700		
Conversion Time (RD Mode)	tCRD	T. T to T	MX7821B/K			875	ns	
		$T_A = T_{MIN}$ to T_{MAX}	MX7821T			975		

TIMING CHARACTERISTICS (continued)

(VDD = +5V, VSS = 0V or -5V, Unipolar or Bipolar Input Range, TA = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNIT	
		$T_A = +25^{\circ}C, C_L = 20pF$				tCRD+25		
		TA = TMIN to TMAX,	MX7821B/K			tCRD+30		
Data-Access Time (RD Mode) (Note 5)	tACCO	$C_L = 20pF$	MX7821T			tCRD+35	ns	
	1.000	$T_A = +25^{\circ}C, C_L = 100p$	oF			tCRD+50		
		TA = TMIN to TMAX,	MX7821B/K			tCRD+65		
		$C_L = 100pF$	MX7821T			tCRD+75		
		$T_A = +25^{\circ}C, C_L = 50pF$			50	80		
RD to INT Delay (RD Mode)	tINTH	TA = TMIN to TMAX,	MX7821B/K			85	ns	
(TID WIGGO)		$C_L = 50pF$	MX7821T			90		
		T _A = +25°C				60		
Data-Hold Time (Note 6)	tDH	T Transito Transi	MX7821B/K			70	ns	
(1.010-0)		$T_A = T_{MIN}$ to T_{MAX}	MX7821T			80		
		T _A = +25°C		350				
Delay Time Between Conversions	tp	T. T to T	MX7821B/K	425			ns	
		$T_A = T_{MIN}$ to T_{MAX}	MX7821T	500			1	
Write Pulse Width	twR	T _A = +25°C		0.250		10	μѕ	
			MX7821B/K	0.325		10		
		$T_A = T_{MIN}$ to T_{MAX}	MX7821T	0.400		10		
			T _A = +25°C		250			
<u>Del</u> ay Ti <u>me</u> Between WR and RD Pulses	t _{RD}	T. T. w. to T	MX7821B/K	350			ns	
		$T_A = T_{MIN}$ to T_{MAX}	MX7821T	450				
RD Pulse Width		$T_A = +25^{\circ}C$ (Figure 3)		160				
VR-RD Mode) t		TA = TMIN to TMAX	MX7821B/K	205			ns	
Determined by tACC1		(Figure 3)	MX7821T	240				
		$T_A = +25^{\circ}C$, $C_L = 20pF$ (Figure 3) (Note 3)				160		
		TA = TMIN to TMAX, CL = 20pF (Figure 3)	MX7821B/K			205		
Data-Access Time (WR-RD Mode)	tACC1	C _L = 20pF (Figure 3) (Note 3)	MX7821T			240	ns	
(Note 5)		T _A = +25°C, C _L = 100p	oF (Figure 3)			185	-	
			MX7821B/K			235		
		$T_A = T_{MIN} \text{ to } T_{MAX},$ $C_L = 100pF \text{ (Figure 3)}$	MX7821T			275		
		T _A = +25°C				150		
RD to INT Delay	t _{RI}		MX7821B/K			185	ns	
		$T_A = T_{MIN}$ to T_{MAX}	MX7821T			220		
		T _A = =25°C, C _L = 50pF	=		380	500		
WR to INT Delay	tINTL		MX7821B/K			610	ns	
		$T_A = T_{MIN}$ to T_{MAX} , $C_L = 50pF$	MX7821T			700		

TIMING CHARACTERISTICS (continued)

(VDD = +5V, VSS = 0V or -5V, Unipolar or Bipolar Input Range, TA = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
RD Pulse Width		$T_A = +25^{\circ}C$ (Figure 4)	$T_A = +25^{\circ}C$ (Figure 4)			65		
(WR-RD Mode) Determined by tACC2	tREAD2	$T_A = T_{MIN}$ to T_{MAX}	MX7821B/K			75	ns	
Determined by tACC2		(Figure 4)	MX7821T			85		
		$T_A = +25^{\circ}C$, $C_L = 20pf$	(Figure 4) (Note 3)			65		
5 · · · · ·		TA = TMIN to TMAX,	MX7821B/K			75		
Data-Access Time (WR-RD Mode)	tACC2	C _L = 20pF (Note 3)	MX7821T		85	85	ns	
(Note 5)		$T_A = +25^{\circ}C, C_L = 100pF (Figure 4)$				90		
		TA = T _{MIN} to T _{MAX} , C _L = 100pF (Figure 4)	MX7821B/K			110		
			MX7821T			130		
WD to INT Dolov	tihwr	$T_A = +25^{\circ}C, C_L = 50pf$				80		
WR to INT Delay (Stand-Alone Operation)		tihwr	$T_A = T_{MIN}$ to T_{MAX} ,	MX7821B/K			100	ns
		$C_L = 50pF$	MX7821T			120		
		$T_A = +25^{\circ}C, C_L = 20pf$	(Note 3)			30		
Data-Access Time		$T_A = T_{MIN}$ to T_{MAX} ,	MX7821B/K			35		
After INT (Stand-Alone Operation) (Note 5)	tiD	C _L = 20pF (Note 3)	MX7821T			40	ns	
		$T_A = +25^{\circ}C, C_L = 100pF$				45		
		$T_A = T_{MIN}$ to T_{MAX} ,	MX7821B/K			60		
		$C_L = 100pF$	MX7821T			70		

 $\begin{tabular}{ll} \textbf{Note 3:} & Guaranteed by design. \\ \textbf{Note 4:} & C_L = 50 pF \ and \ R_L = 5 k\Omega \ pull-up \ resistor. \\ \textbf{Note 5:} & See \ Figure 1 \ for \ load \ circuit. \ Parameter \ defined \ as the time \ required for the output to \ cross \ +0.8V \ or \ +2.4V. \\ \textbf{Note 6:} & See \ Figure 2 \ for \ load \ circuit. \ Parameter \ defined \ as the time \ required for \ data \ lines to \ change \ 0.5V. \\ \end{tabular}$

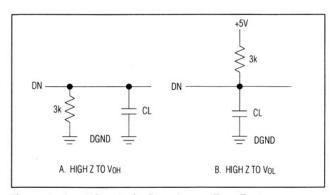


Figure 1. Load Circuits for Data-Access Time Test

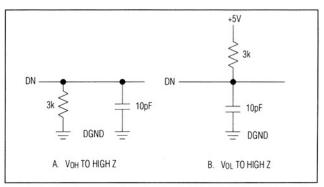


Figure 2. Load Circuits for Data-Hold Time Test

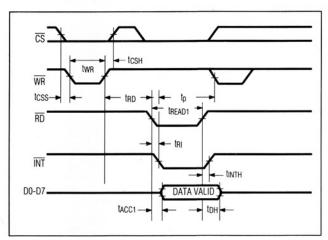


Figure 3. WR-RD Mode Timing (t_{RD} < t_{INTL})

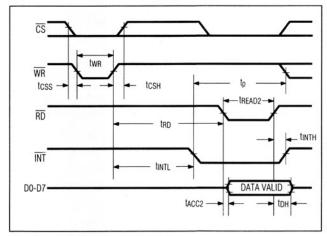


Figure 4: WR-RD Mode Timing (t_{RD} > t_{INTL})

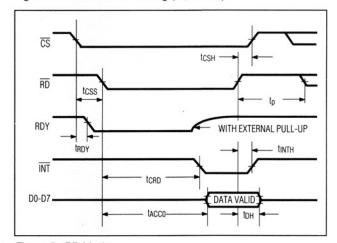


Figure 5. RD Mode

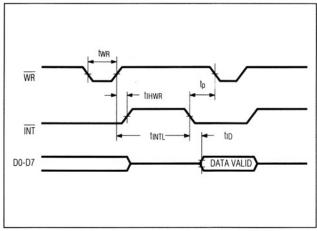
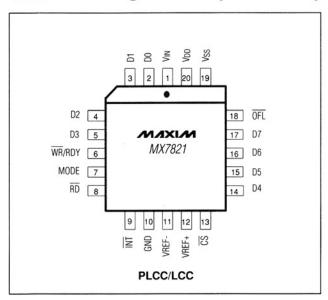


Figure 6. WR-RD Mode Stand-Alone Operation ($\overline{CS} = \overline{RD} = 0$)

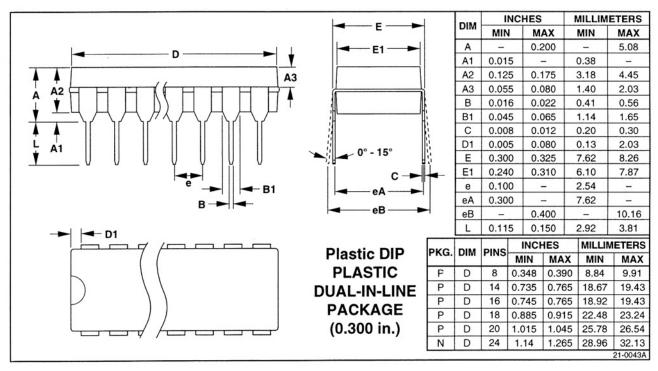
Pin Configurations (continued)

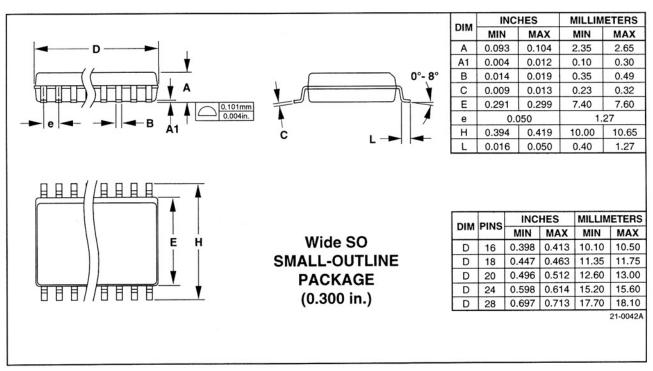


For application information, refer to the MX7820 data sheet.

Package Information

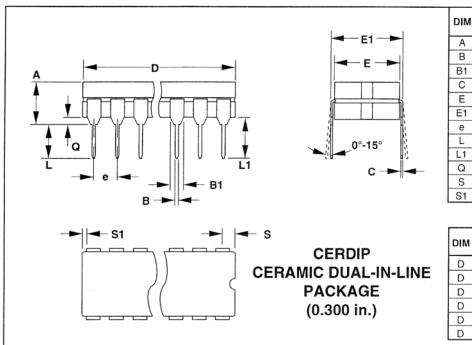
(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)





Package Information (continued)

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information go to www.maxim-ic.com/packages.)



DIM	INC	HES	MILLIM	IETERS
DIW	MIN	MAX	MIN	MAX
Α	_	0.200		5.08
В	0.014	0.023	0.36	0.58
B1	0.038	0.065	0.97	1.65
С	0.008	0.015	0.20	0.38
Е	0.220	0.310	5.59	7.87
E1	0.290	0.320	7.37	8.13
е	0.1	0.100		54
L	0.125	0.200	3.18	5.08
L1	0.150	_	3.81	-
Q	0.015	0.070	0.38	1.78
S		0.098	_	2.49
S1	0.005	_	0.13	_

DIM PINS		INC	HES	MILLIMETERS		
DIIVI	PINS	MIN	MAX	MIN	MAX	
D	8	_	0.405	_	10.29	
D	14		0.785		19.94	
D	16	-	0.840	_	21.34	
D	18	_	0.960	_	24.38	
D	20		1.060	-	26.92	
D	24		1.280	-	32.51	

21-0045A

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